Amendments to the Claims:

1. (Currently amended) A test key layout, comprising:

a first test pattern substantially disposed at a center position of a test key area, wherein said first test pattern consists of a pair of rectangular shaped symmetric patterns having a length L and a width W, and wherein said test key area comprises a reference X-Y coordinate;

a second test pattern arranged in proximity to said first test pattern in 45 degree directions with respect to said first test pattern; and

a third test pattern disposed next to said first test pattern along an X axis of said reference X-Y coordinate; and

a fourth test pattern disposed a distance S_1 from said first test pattern along a Y-axis of said reference X-Y coordinate.

wherein said first test pattern, said second test pattern, and said third test pattern are arranged like a capital "H" within said test key area.

- 2. (Original) The test key layout of claim 1 wherein said test key layout is made on a photomask comprising an array of deep-trench (DT) capacitor patterns, and wherein said rectangular shaped symmetric patterns have a dimension that is substantial equal to dimension of said DT capacitor patterns.
- 3. (Original) The test key layout of claim 1 wherein said test key layout is capable of exclusively monitoring 3-foil aberration effect without affected by co-existed COMA aberration effect.

4. (Canceled)

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- 5. (Original) The test key layout of claim [[4]] wherein $S_1 = 3L$.
- 6. (Original) The test key layout of claim 1 wherein said second test pattern is disposed a distance S_2 from said third test pattern.
- 7. (Original) The test key layout of claim 6 wherein $S_2 = L$.
- 8. (Original) The test key layout of claim 1 wherein said third test pattern is disposed a distance S₃ from said first test pattern.
- 9. (Original) The test key layout of claim 8 wherein $S_3 = W$.